

Cure kinetics of epoxy–amine resins used in the restoration of works of art from glass or ceramic

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Abstract

The cure kinetics of two epoxy/amine resins, Araldite 2020 and AY103-HY956 widely used as adhesives in the restoration of works of art from glass or ceramic was investigated using FTIR spectroscopy. These resins are two-part adhesives, consisting of a resin – A, based on a diglycidyl ether of bisphenol A, and a hardener – B which is either a cycloaliphatic amine (isophorone diamine) for Araldite 2020, or a mixture of three aliphatic amines in HY956. The study was based on the collection of IR spectra, in the middle range ($4000\text{--}600\text{ cm}^{-1}$), of mixtures of resin and hardener at different proportions and isothermal temperatures ($22\text{--}70\text{ }^{\circ}\text{C}$) as a function of curing time. A kinetic model was employed to simulate the experimental data using two kinetic rate constants. Diffusion control was incorporated to describe the cure behaviour at high degrees of conversion. From fitting to experimental data the kinetic and diffusional parameters were estimated, together with the activation energies of the kinetic and autocatalytic rate constants. It was found that higher degrees of curing are obtained at higher temperatures and increased amounts of hardener. Differences in the performance of the two adhesives are explained based on the type of the amines used as hardener.

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1. Introduction

A good adhesive in order to be used for conservation and restoration of glass needs certain properties. It should be clear, colourless and with a refractive index close to that of glass, so that to become invisible in the glue line. Also it should retain this quality and should not discolour, shrink

or embrittle upon ageing, as well as it should be strong enough to perform the job. In addition, it should not release any harmful volatiles upon curing or ageing, be easy to use, have a good shelf-life and be inexpensive. No adhesive can satisfy all these demands, since each one exhibits some advantages and disadvantages. Therefore, selecting a glass adhesive is a matter of compromise [1,2]. The adhesives used for glass repairs include polyurethanes, acrylic and cyanoacrylic esters, epoxy resins, silicones, polyesters etc. Epoxy resins generally are expensive, but the long service time and good

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physical properties often help by providing a favourable cost-performance ratio when compared to other materials. Their advantages include curing at room temperature with low shrinkage, refractive index similar to that of glass and very high polarity. This last property is responsible for the formation of strong chemical bonds between the adhesive and the glass substrate. Epoxy resins are also used in conservation, for wood and stone consolidation and repair, consolidation of corrosion layer in metal, tear repair for paintings and as adhesives in ceramic conservation [3,4].

Among the epoxy resins specifically designed for glass bonding are Araldite 2020 (XW396/XW397) and Araldite AY103/HY956. Araldite is a Ciba-Geigy trade name, which is now owned by Huntsman Advanced Materials. They are two-part adhesives, consisting of a resin – A and a hardener – B that perform strong adhesion, curing at room temperature, extremely low shrinkage and resistance to humidity and mechanical stresses. The resin of both is based on a diglycidyl ether of bisphenol A (DGEBA), while the hardener is a cycloaliphatic amine (isophorone diamine) for Araldite 2020 and a mixture of different aliphatic amines in HY956. Araldite 2020 may also be used to bond metal, ceramics, rubber and rigid plastics and exhibits a refractive index similar to glass together with good chemical, heat and water resistance. Although these commercial products are extensively used, there is not any published paper dealing with their cure kinetics. The degree of curing as a function of time, as well as the time required for the complete cure is of great importance since it determines the time that is available for the application of the adhesive. Several parameters, such as temperature, hardener/epoxy ratio, type of amine or epoxy used, etc., affect cure kinetics. Therefore, the aim of this investigation is to study the kinetics of these epoxy resins at different reaction conditions.

Cure kinetics of epoxy resins have been studied experimentally with different techniques, such as Fourier transform infrared (FTIR) and Raman spectroscopy [5–11], gel permeation chromatography [12], thermal analysis as differential scanning calorimetry (DSC) [13–27], dielectric relaxation spectroscopy [28,29] and different approaches have been used to describe it. Using FTIR the evolution of the oxirane ring absorbance, at 915 cm^{-1} , is recorded in relation to a reference vibration band, whose intensity does not vary during the curing process. In contrast, indirect methods of analysis, like

DSC, give only an assessment of the degree of cure by monitoring, as a function of time, the amount of heat released assuming that it is proportional to the rate of polymerization. Among these methods, FTIR spectroscopy represents the most attractive choice owing to the unmatched wealth of molecular level information contained in the infrared portion of the electromagnetic spectrum [5]. Furthermore, several models arising from proposed kinetic mechanisms have been used to fit the experimental data. Due to the complex chemistry involved in the epoxy curing, a phenomenological approach is the most popular for these systems. Besides classical kinetic expressions, phenomena such as autocatalysis in the early stages or the effect of diffusion on the kinetic rate constants at later stages can further complicate modelling. Development of a good kinetic model enables one to predict how the system will behave during cure and what the final degree of curing will be. Thus, the experimental work required to establish a cure cycle for any new conditions is minimized.

In this paper, cure kinetics of both Araldite 2020 and AY103/HY956 was investigated at different isothermal reaction temperatures (from 22 to 70 °C) and hardener/epoxy ratios using FTIR. A kinetic model was employed to simulate the experimental data and kinetic and diffusional parameters were estimated at all different conditions. The effect of the different type of hardener used in these resins (i.e., cycloaliphatic or a mixture of aliphatics) on the cure kinetics (i.e., autocatalytic or n th order) is also illustrated.

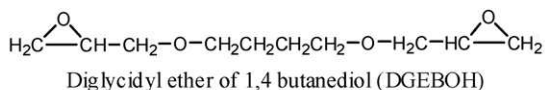
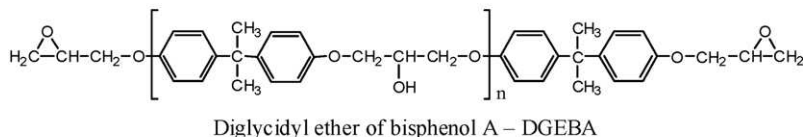
2. Experimental

2.1. Materials

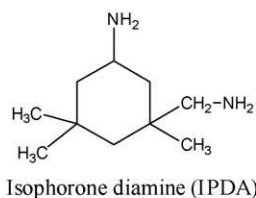
Araldite® 2020 consists of two components A and B and it was supplied by Huntsman, Switzerland (Batch No. AD30940500). Component A, is a mixture of two epoxy resins, i.e., the diglycidyl ether of bisphenol A (DGEBA) (CAS No. 25068-38-6) with a number average molecular weight, $M_n < 700$ (corresponding to $n = 0$, or 1) (40–52% w/w) and the diglycidyl ether of 1,4-butanediol (DGEBOH) (CAS No. 2425-79-8) (50–62% w/w) as reactive diluent. Component B, the hardener, consists of a cycloaliphatic amine, the isophorone diamine (IPDA). The chemical structure of the epoxy compounds and amine used appear in Fig. 1. The epoxide equivalent weight (EEW) of component A, defined as the grams of resin containing 1 gmol

Araldite 2020

Component A. Epoxy resins

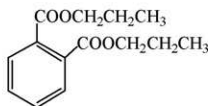


Component B. Hardener

**Araldite AY103/HY 956**

Component A. epoxy resin

DGEBA containing the plasticizer dibutyl ester of 1,2-benzenedicarboxylic acid



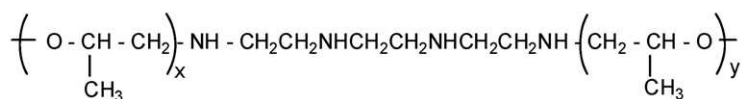
Component B. amines



Diethylene triamine (DETA)



Triethylene tetramine (TETA)



Triethylenetetramine propoxylated

Fig. 1. Molecular structure of epoxy compounds and amines used.

of epoxy group, was determined by titration according to literature [30] and it was found equal to 224.29 g/eq. The amine hydrogen equivalent weight (AHEW) was calculated by using the following equation: $\text{AHEW} = \text{molecular weight of the amine} / \text{number of active amine hydrogens}$. The isophorone diamine with a molar mass of 170.3 g/mol contains four active hydrogen atoms and acts theoretically as a tetramine. Thus AHEW of isophorone diamine is equal to $170.3/4 = 42.57$ g/eq. Since it is assumed that one amine hydrogen reacts with one epoxy group the stoichiometric ratio of hardener to use with the epoxy resin is given by

the ratio: $\text{AHEW} \times 100 / \text{EEW}$ of resin or $42.57 \times 100 / 224.29 = 19$ phr (phr = parts by weight of amine per 100 parts of resin). The supplier of Araldite 2020 recommends the use of phr = 30 for this system. Therefore, the phr ratios used in the present work were 30, 25 and 20, which correspond to 58%, 25% and 5% excess of amine, respectively.

Araldite® AY103/HY956 consists also of two components A and B and it was supplied by Huntsman, Switzerland (Batch No. AD 40374400). Component A is again DGEBA containing the plasticizer dibutyl ester of 1,2-benzenedicarboxylic acid (16.7% w/w), while component B is a mixture of

three amines, i.e., diethylene triamine (DETA), triethylene tetramine (TETA) and propoxylated triethylene tetramine (Fig. 1). The epoxide equivalent weight (EEW) of component A was determined again by titration and it was found equal to 291.4 g/eq. The supplier of this adhesive recommends the use of $\text{phr} = 18$ for this system. The AHEW of the hardener was 52.45 g/eq.

2.2. Sample preparation

For each Araldite studied the appropriate amounts of the two components A (epoxy resin) and B (hardener) were completely mixed by stirring at room temperature until they formed a homogeneous mixture. From this solution, several samples were prepared by casting a thin film on a glass plate covered by a polyethylene film and followed by covering the sample with another glass-polyethylene plate. These sandwich-like glass plates were placed in a thermostated oven (TERMAKS, B8000 series, mod. B 8054) at several curing temperatures (22, 50 or 70 °C). At pre-specified time intervals, each glass plate was removed and the sandwich-like polyethylene plate was mounted in an FTIR spectrometer.

2.3. FTIR measurements

The FTIR spectra of the samples were recorded at room temperature immediately after the oven cure. Since very slow reaction rates were observed (reaction lasted for more than a day in some experiments) compared to the time of measurement (only a few seconds), no polymerization was assumed to occur during the measurement [23]. A different sample was used at each time interval. All the spectra were obtained at a resolution of 4 cm^{-1} using a Perkin–Elmer Spectrum One, FTIR. The recorded wavenumber range was from 600 to 4000 cm^{-1} and 16 scans were averaged to reduce the noise. A commercial software Spectrum v5.0.1 (Perkin Elmer LLC 1500F2429) was used to process and calculate all the data from the spectra. The sample (sandwich-like polyethylene plate) was taken out of the glass plate and placed on a NaCl pellet since KBr may act as a catalyst in the reaction.

The relative conversion (α) of the epoxy groups denoting the degree of curing at any time, t , was calculated by the following equation:

$$\alpha = (C_0 - C_t)/C_0 = 1 - C_t/C_0 \quad (1)$$

or taking into account that the Beer–Lambert law holds, by the relation:

$$\alpha = 1 - \frac{(A_{\text{epoxy}}/A_{\text{ref}})_t}{(A_{\text{epoxy}}/A_{\text{ref}})_0} \quad (2)$$

where C is the concentration and A the absorbance of the group; the subscripts 0 and t denote zero and reaction time t , respectively; the subscripts epoxy and ref are used to denote the characteristic epoxy and reference peak, respectively. The reference peak used as an internal standard for the normalization of epoxy peak absorbance is that of p -phenylene group at 833 cm^{-1} . The analytical peak used for the epoxy group was that of oxirane ring deformation at 915 cm^{-1} . The peak area was used according to Ref. [6].

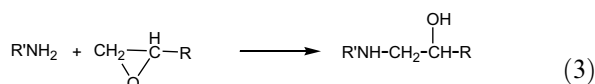
All the results presented in the following sections were taken from an average of at least three experiments.

3. Theoretical background

Kinetic modeling of the curing process, as in every polymerization reaction, can be approached in two ways: either mechanistic or semi-empirical [6]. The first approach is based on a detailed knowledge of the elementary reactions taking place during curing and in writing the rate equations for every single step. Accordingly population balances are derived for all chemical species present in the reactor, which constitute a set of simultaneous differential equations describing the time evolution of every component involved in the reaction. These equations are usually solved numerically provided that the appropriate rate constants of every elementary reaction are known. These are usually evaluated by fitting the simulation model to appropriate experimental data. This is a rather complicated process, which requires measurement of different properties changing during the reaction in order to provide a set of parameters having physical meaning. Not to mention the computational effort especially when side reactions together with diffusional phenomena play an important role in the process. The semi-empirical approach is a more straightforward method based on the identification only of characteristic functional groups reacting (i.e., epoxy group, etc.) and not on the individual species. Thus, simpler equations easily solved are obtained with a smaller number of parameters needed to be evaluated.

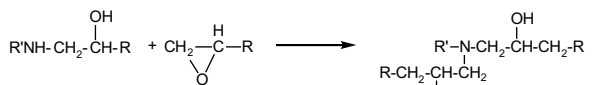
A simple, yet general set of equations describing epoxy–amine polymerization involves three main reactions and may be expressed as [31]:

(1) Primary amine addition



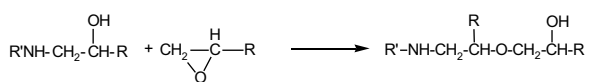
Primary amine Epoxide Secondary amine with hydroxyl group

(2) Secondary amine addition



secondary amine epoxide Tertiary amine with hydroxyl groups

(3) Etherification reaction



Secondary amine with ether and hydroxyl group

According to this kinetic scheme and with the simplifying assumptions of equal reactivity of primary and secondary amino-hydrogen with epoxy groups and a stoichiometric ratio of epoxy to amino-hydrogen groups, the following equation was obtained [13,18]:

$$\frac{d\alpha}{dt} = (k_1 + k_2\alpha)(1 - \alpha)^2 \quad (6)$$

where α denotes conversion of the epoxy groups and the rate constants k_1 and k_2 correspond, respectively, to catalysis by groups initially present in the resin and catalysis by hydroxyl groups newly formed in the reaction. These rate constants depend on temperature with an Arrhenius-type expression:

$$k_i = A_i \exp(-E_i/RT) \quad (7)$$

where A_i denotes the frequency factor of the k_i rate constant and E_i its corresponding activation energy.

If the epoxy and amine functional groups are not initially present in stoichiometric quantities then Eq. (6) is transformed to the following [13,32,33]:

$$\frac{d\alpha}{dt} = (k_1 + k_2\alpha)(1 - \alpha)(B - \alpha) \quad (8)$$

where B is the ratio of primary amine N–H bonds to epoxide functional groups in the initial mixture.

Furthermore, Kamal et al. [34,35] extended the so-called autocatalytic model using two additional empirical power law exponents m and n in addition to the kinetic rate constants k_1 and k_2 . Thus Eq. (6) becomes:

$$\frac{d\alpha}{dt} = (k_1 + k_2\alpha^m)(1 - \alpha)^n \quad (9)$$

This equation takes into account the autocatalytic nature of the curing process with the term $k_2\alpha^m$, while the n th order uncatalyzed process is represented by k_1 . Eq. (6) can be derived from Eq. (9) using the values $m = 1$ and $n = 2$.

Many workers proposed different values of the empirical reaction orders m and n , which were found to vary significantly with temperature [23,25]. Cole [36] recently developed a more rigorous model describing the cure kinetics of general epoxy–amine systems. He concluded that the reaction could be divided into two stages. At the beginning of the cure, the amine–epoxide reaction dominates and the effect of the etherification reaction is insignificant, so Eq. (8) is valid for the initial reaction. But in the later stages of curing, the isothermal cross-linking reaction tends to become simply first order with respect to epoxide concentration.

Eq. (9) was extensively used in literature and describes well the experimental data when epoxy conversion is completed (final degree of curing approaching 100%). However, when the epoxy resins polymerize at temperatures below the glass transition temperature of the polymer being formed, the curing reaction does not reach complete conversion. As the conversion increases and the T_g of the mixture approaches the reaction temperature, the diffusivity of the reactive functional groups becomes seriously restricted. Thus, the curing reaction decreases considerably even when there may be a significant level of amino and epoxide groups available for reaction. Hence, a limiting conversion is usually achieved which is increased with the polymerization temperature. Kenny and coworkers [37], accounted for this effect by replacing the term $(1 - \alpha)$ in Eq. (9) by $(\alpha_{\max} - \alpha)$, with α_{\max} representing the final conversion reached at the specified temperature. Thus, Eq. (9) is transformed to:

$$\frac{d\alpha}{dt} = (k_1 + k_2\alpha^m)(\alpha_{\max} - \alpha)^n \quad (10)$$

Several authors used more fundamental approaches to model the effect of diffusion control on the polymerization kinetics [18,38]. Accordingly the overall kinetic rate constant k is expressed in terms of a reaction-limited term k_{chem} and a diffusion-limited one k_{diff} [15,18].

$$\frac{1}{k} = \frac{1}{k_{\text{chem}}} + \frac{1}{k_{\text{diff}}} \Rightarrow \frac{k}{k_{\text{chem}}} = \frac{1}{1 + k_{\text{chem}}/k_{\text{diff}}} \quad (11)$$

the model proposed by Cook et al. [18] while more theoretically correct, it requires the determination of the change of the glass transition temperature as a function of curing conversion, which is not always known. In contrast, Chern and Poehlein [38] proposed a very simple equation coming from the free volume theory to estimate the ratio of the diffusion-controlled to reaction limited rate constant:

$$\frac{k_{\text{diff}}}{k_{\text{chem}}} = \exp(-C(\alpha - \alpha_c)) \quad (12)$$

where C is a constant that depends on the structure, system and curing temperature and α_c is a critical conversion.

Thus the effective kinetic rate constants can be calculated using Eqs. (11) and (12) [15,36]. For values of α significantly lower than α_c the term $k_{\text{chem}}/k_{\text{diff}}$ is approximately equal to zero and $k/k_{\text{chem}} \cong 1$. This means that diffusion-controlled is negligible and the overall reaction kinetic rate constants are reaction-limited. When α approaches α_c , k/k_{chem} begins to decrease, reaching 0.5 when $\alpha = \alpha_c$. Beyond this point it continuously to decrease eventually approaching zero, so that the reaction becomes very slow and effectively stops. Therefore, α_c seems to correspond to a critical conversion above which vitrification is efficient, i.e., the vitrification conversion.

Later on Fournier et al. [28] modified Cole's equation as follows:

$$\frac{k}{k_{\text{chem}}} = \frac{2}{1 + \exp[(\alpha - \alpha_f)/b]} - 1 \quad (13)$$

with α_f denoting the final degree of curing and b a constant.

A comparison of the results obtained using Eqs. (11) and (12) with those from Eq. (13) and arbitrarily chosen values for the parameters α_c , C ($C = 22$, $\alpha_c = 0.64$) and α_f , b ($\alpha_f = 0.82$, $b = 0.09$) appears in Fig. 2. It is seen that both equations correspond to a gradual decrease with respect to degree of curing, while the Cole–Poehlein model presents also a gradual change during very high degree of α . The Fournier et al. model presents monotonically decrease function with values of k/k_{chem} less than zero when $\alpha > \alpha_f$.

From the aforementioned models and trying to keep the model adjustable parameters as few as possible, in this investigation we used the simple Horie Eq. (8) together with the diffusion model of Cole–Poehlein (Eqs. (11) and (12)). Thus, the final equation used can be written as [24]:

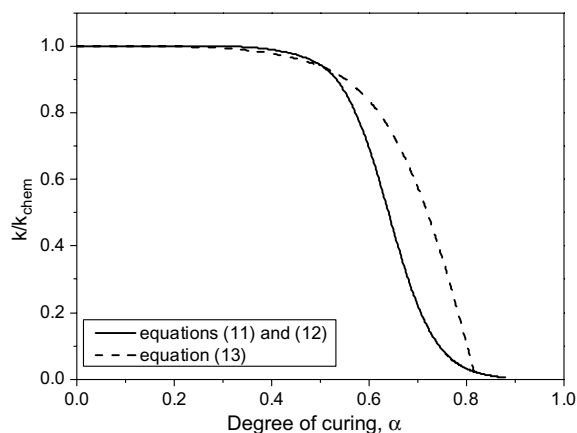


Fig. 2. Effect of the equation used to describe diffusion-controlled phenomena on the change of kinetic rate constants, as a function of the degree of curing during the epoxy–amine curing reaction.

$$\frac{d\alpha}{dt} = (k_1 + k_2\alpha)(1 - \alpha)(B - \alpha) \frac{1}{1 + \exp(C(\alpha - \alpha_c))} \quad (14)$$

4. Results and discussion

4.1. Analysis of the IR spectra

Fig. 3a and b shows the FTIR spectrum of the Araldite® 2020 film before and after curing, respectively. Several peaks are identified in Fig. 3a assigned either to the epoxy resin or to the hardener. The most important of these peaks is that of the oxirane ring at 915 cm^{-1} . Absorption at 3369 , 3298 , and 3174 cm^{-1} is due to stretching vibration of the primary amino group ($-\text{NH}_2$) on the hardener structure. This group shows also an absorption peak at 1608 cm^{-1} . The strong peak at 2920 cm^{-1} is due to the stretching vibration of $-\text{CH}_2-$ groups. The ether groups on the DGEBA molecule is characterized by three absorption peaks at 1250 , 1038 and 950 cm^{-1} . The strong band at 1250 cm^{-1} is due to aromatic carbon–oxygen stretching, while the band at 1038 cm^{-1} results from the aliphatic carbon–oxygen stretching ($-\text{O}-\text{CH}_2-$). Finally, the bands at 1510 cm^{-1} and 833 cm^{-1} can be assigned to *p*-phenylene groups, while that at 950 cm^{-1} is due to the epoxy ether group. After the end of cure, the epoxide group and the primary amine peaks both decreased in size (Fig. 3b). On the contrary new absorptions appear were revealed around 3400 cm^{-1} due to secondary amine (N–H) and

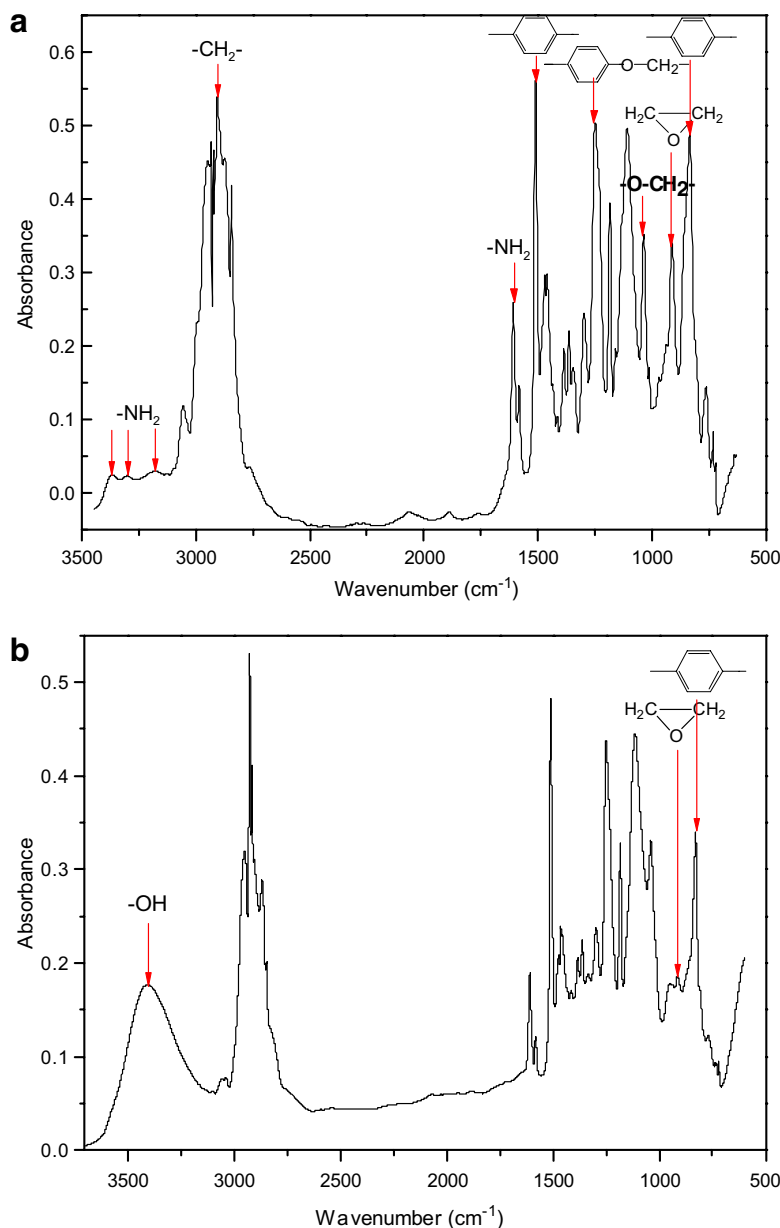


Fig. 3. FTIR spectrum, in the 3500–600 cm^{-1} wavenumber range of Araldite 2020 thin film, before (a) and after curing (b).

hydroxyl groups formed during cure (Fig. 3b). The spectrum evolution of the Araldite[®] 2020 during curing at different times is illustrated in Fig. 4. A decrease in the area of the oxirane ring at 915 cm^{-1} is obvious. It is also observed that the reference band of the *p*-phenylene groups at 833 cm^{-1} and 1510 cm^{-1} remain nearly constant throughout the treatment time. Repetitive experiments using either the peak at 833 cm^{-1} or that at 1510 cm^{-1} as a reference gave approximately the same results.

Therefore, for quantitative measurements the band at 833 cm^{-1} was used in this paper.

4.2. Evaluation of kinetic parameters

In order to evaluate the kinetic parameters appearing in Eq. (14) instead of estimating simultaneous four adjustable parameters, which perhaps would result in highly correlated values, the following procedure was followed. Initially the effect of

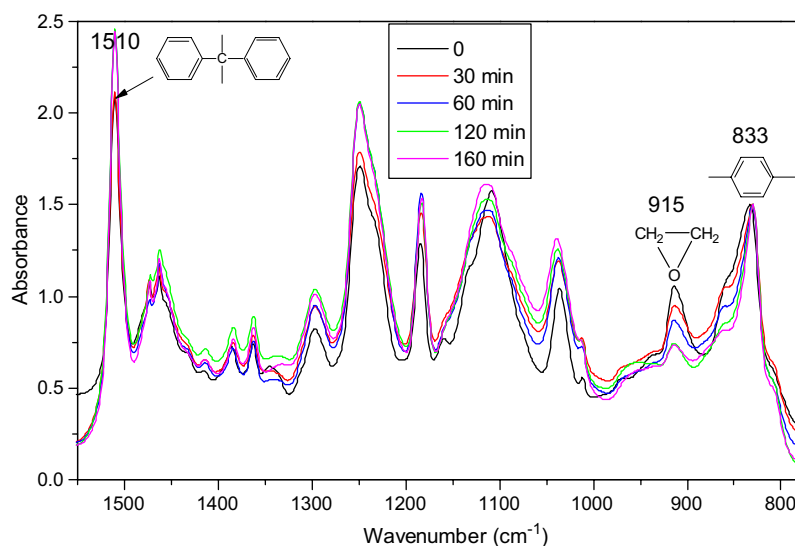


Fig. 4. FTIR spectra in the wavenumber range 1550–800 cm^{-1} obtained at different times for the curing of Araldite 2020 at 70 °C; resin/hardener = 100/30 w/w.

diffusion-controlled phenomena was ignored. Thus, Eq. (8) could be integrated analytically to give:

$$C_1 \ln \left(\frac{k_1 + k_2 \alpha}{k_1} \right) + C_2 \ln(1 - \alpha) - C_3 \ln \left(\frac{B - \alpha}{B} \right) = t \quad (15)$$

with:

$$C_1 = \frac{k_2(1 - B)}{(1 - B)[k_1^2 + k_2^2 B + (1 + B)k_1 k_2]}$$

$$C_2 = \frac{k_1 + k_2 B}{(1 - B)[k_1^2 + k_2^2 B + (1 + B)k_1 k_2]}$$

$$C_3 = \frac{k_1 + k_2}{(1 - B)[k_1^2 + k_2^2 B + (1 + B)k_1 k_2]}$$

Eq. (15) provides an algebraic equation, which by means of some non-linear least-squares procedure, can be used to fit the experimental data of α as a function of time at different curing temperatures and amine/epoxy ratios. The best fitting values of the kinetic parameters k_1 and k_2 can then be estimated. Indicative results for the ratio of hardener to epoxy 20:100 wt/wt at 22 °C and 50 °C appear in Fig. 5. It was observed that the purely kinetic model fitted the experimental data very well at low conversions (α less than approximately 50%). However, the values measured at higher curing times were always overestimated. Thus, keeping the values of k_1 and k_2 estimated using low conversion data, the two diffusional parameters C and α_c can

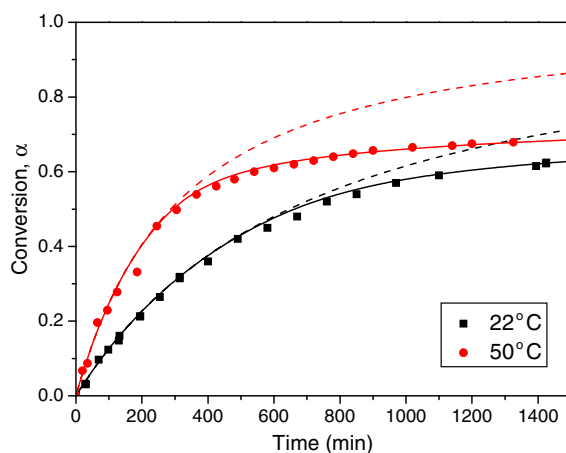


Fig. 5. Epoxy conversion versus time for the Araldite 2020 (phr = 30) at 22 °C and 50 °C. Solid lines were produced using Eq. (14), while dashed using Eq. (15) and omitting the effect of diffusion-controlled phenomena on the cure kinetics.

be determined by fitting now the complete differential equation (14) to the experimental data. Using this procedure, the experimental data are simulated very well during the whole reaction time and the best set of adjustable parameters can be obtained.

4.3. Kinetics of Araldite 2020

Fig. 6a, b and c show the effect of isothermal temperature on the conversion vs. time at three constant resin/hardener ratios 100:30, 100:25 and

100:20 w/w, respectively. It can be observed that conversion increases with time under given isothermal conditions and with temperature of isothermal cure. Initially the curing rate is high and later levels off resulting in a final degree of curing less than one in all experiments. The concentration of epoxy groups is not changed with further isothermal heating, although a number of residual epoxy groups remained un-reacted. This final degree of curing increases with temperature and is attributed to the effect of diffusion-controlled phenomena and the restricted mobility of the functional groups to come into close contact in order to react. At the 100:30 resin/hardener ratio (recommended by the supplier) after approximately 1 day of curing, the maximum epoxy conversion, α , was approximately 74% at 22 °C, increased to 93% at 70 °C. The corresponding values measured at the almost stoichiometric ratio of resin/hardener (100:20 w/w) were 63% at 22 °C and 78% at 70 °C.

Furthermore, using the procedure described in Section 3.2 the best fitting values of the adjustable parameters were calculated and are illustrated in Table 1. Using these values differential Eq. (14) is integrated to provide the theoretical simulation curves of α as a function of time. The kinetic model results are also included in Fig. 6a, b and c as continuous lines. As it can be easily seen, the kinetic theoretical model simulates the experimental data very well at all different experimental conditions and during the whole evolution of conversion. From the values reported in Table 1, it can be seen that the estimated values of C were unaffected by temperature. Concerning the variation of C with temperature, no discernible trend was also observed in literature [15,16,24]. The estimated values range between 12 and 22 and are slightly lower than corresponding literature values (17–32 [16], 18–40 [24]). In contrast, the critical conversion, α_c , was found to increase with temperature, again in accordance to literature data [15,16,24,39]. Since α_c corresponds to the vitrification conversion, i.e., conversion above which the effect of diffusion-controlled phenomena is important, it is expected that increased temperature increases the mobility of molecules and thus the onset of diffusion control may be shifted to higher values. Furthermore, it was interesting to compare these values with the gelation point (conversion at which a 3-dimensional network is formed). Theoretically, gelation occurs at a certain degree of cure that depends only on the functionality of the amine and epoxy. In the system

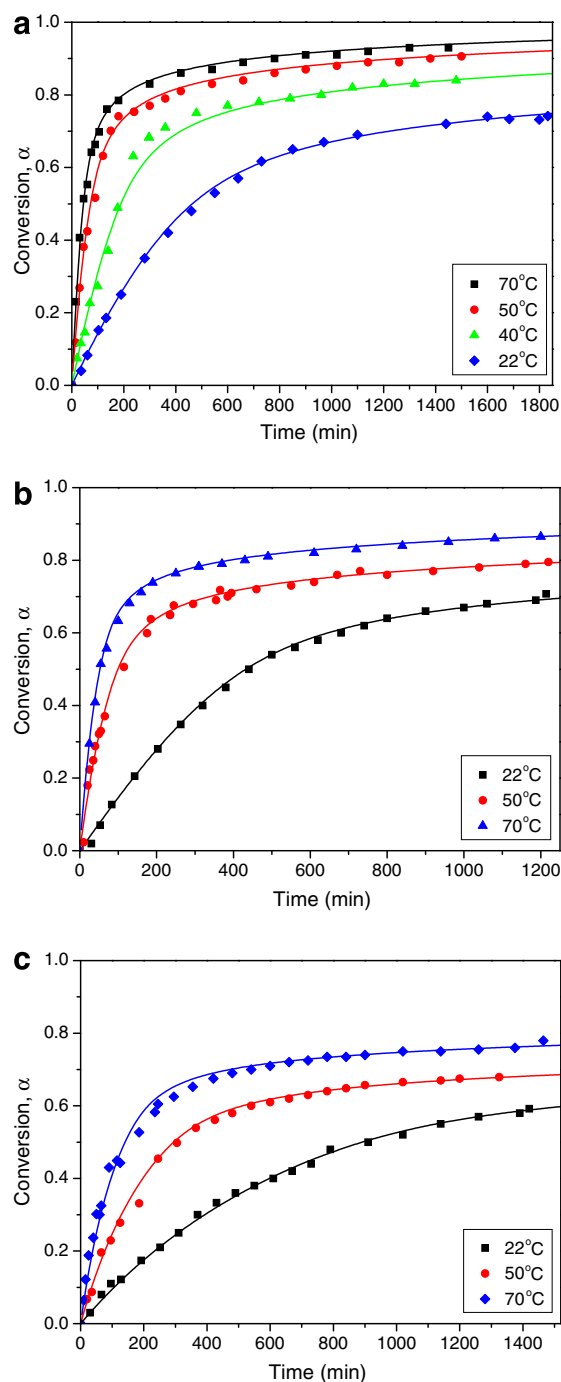


Fig. 6. Effect of isothermal temperature on the extent of conversion vs. time for Araldite 2020, cured at three constant resin/hardener ratios 100:30 (a), 100:25 (b) and 100:20 (c). Experimental data and kinetic model predictions.

examined, the amine is tetrafunctional and the epoxy is bifunctional so that the theoretical value

Table 1

Kinetic and diffusional parameters at different temperatures and hardener/epoxy ratios of Araldite 2020

Ratio of hardener to epoxy (wt/wt)	Ratio of amine equivalent to epoxy (<i>B</i>)	Temperature (°C)	$k_1 \times 10^3$ (min ⁻¹)	$k_2 \times 10^3$ (min ⁻¹)	<i>C</i>	α_c
30:100	1.58	22	0.95	1.0	12	0.61
		40	2.2	2.7	12	0.66
		50	6.4	4.5	12	0.68
		70	10	8.0	12	0.69
25:100	1.25	22	1.2	2.0	15	0.60
		50	6.5	4.0	15	0.60
		70	12	7.5	15	0.66
20:100	1.05	22	0.98	0.3	22	0.58
		50	3.0	0.8	22	0.58
		70	6.0	2.2	22	0.64

of the extent of cure at gelation, α_{gel} for a stoichiometric amine/epoxy ratio should be [40]:

$$\alpha_{\text{gel}} = \left(\frac{1}{(f_A - 1)(f_E - 1)} \right)^{1/2} = \left(\frac{1}{(4 - 1)(2 - 1)} \right)^{1/2} = 0.577 \quad (16)$$

where f_A and f_E are the respective functionalities of the amine and epoxy.

Comparing this value (0.577) with those obtained for α_c in the near stoichiometric ratio ($B = 1.05$) and reported in Table 1, it is evident that α_{gel} is almost equal to α_c at low reaction temperatures (22 and 50 °C), whereas a higher α_c value was estimated at 70 °C.

Moreover, the values of the kinetic rate constants k_1 and k_2 are plotted as a function of temperature in an Arrhenius-type plot in Fig. 7a and b. The Activation energies, E_1 and E_2 calculated from the slopes of the straight lines, depend on the initial epoxy/amine ratio and are equal to: $E_1 = 43.4$, 41.1 and 31.8 kJ/mol and $E_2 = 36.8$, 28.3, 34.2 kJ/mol for $B = 1.58$, 1.25 and 1.05, respectively. It was observed that at high epoxy/amine ratios, the non-catalytic activation energy E_1 , is greater than the autocatalytic, E_2 , while at the almost stoichiometric ratio approximately equal values were obtained. It should be noted here that in literature both trends were reported (i.e., either $E_1 > E_2$, or $E_1 < E_2$) depending on the system and conditions examined. The E_1 and E_2 values estimated in this paper were slightly lower than corresponding literature values for different epoxy–amine systems (47.5 and 52.9 kJ/mol [23], 52 and 42 kJ/mol [18], 61.5 and 51.3 [7] and 61.2 and 47.7 [17]). Furthermore, Vyazovkin and Sbirrazzuoli in a series of papers

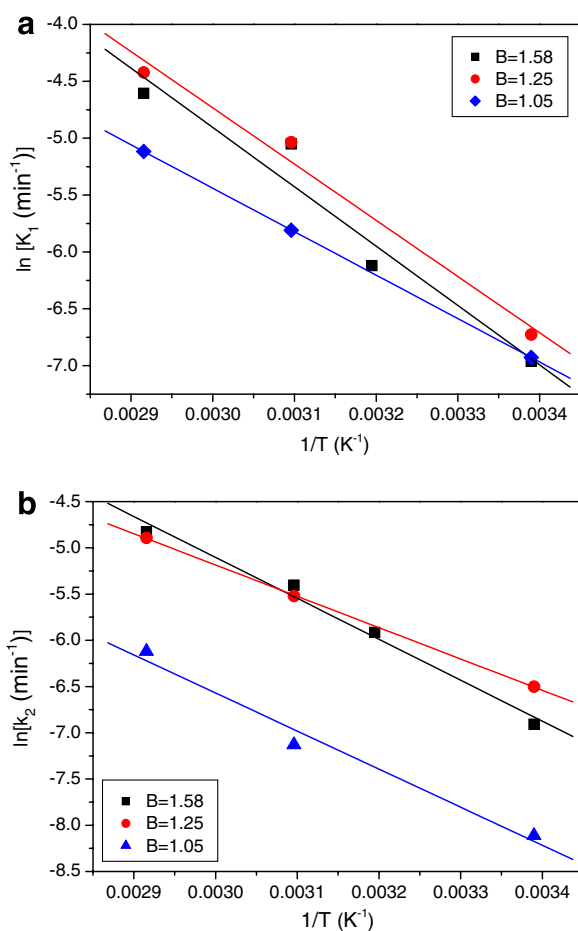


Fig. 7. Arrhenius-type plots of the kinetic rate constant k_1 (a) and the autocatalytic rate constant k_2 (b) as a function of temperature obtained from curing of Araldite 2020 at three initial amine/epoxy ratios, B .

[20,21,41,42] used the isoconversional kinetic analysis to study the kinetics of epoxy–amine systems.

The effect of viscosity on the kinetics of initial cure stages was also examined [42]. These authors, using an isoconversional approach for a similar epoxy–amine system estimated that the overall activation energy should be a function of the extent of cure and take values in the range of 30–45 kJ/mol [21]. According to isoconversional methods the reaction rate at constant extent of conversion is only a function of temperature. Therefore, the cornerstone of any isoconversional method is that one must have different experimental data at a constant extent of conversion. This can be easily carried out using an experimental technique, such as DSC where experimental data are recorded continuously. However, in such a technique like FTIR, used in this investigation, the experimental data are discrete and not continuously recorded. The IR spectrum is recorded at pre-specified time intervals which does not assure the measurement of the same extent of conversion at different experimental conditions. Therefore, by default the isoconversional analysis cannot be used in the experimental data of this manuscript.

Finally, Fig. 8 shows the effect of the resin/hardener ratio on the degree of epoxy conversion vs. time at a constant curing temperature. At each temperature studied it was observed that the initial conversion versus time data were almost the same at initial ratios of amine/epoxy equal to $B = 1.58$, or $B = 1.25$, while much smaller at the almost stoichiometric ratio of $B = 1.05$. The maximum degree of curing increased with the amine/epoxy ratio at high temperatures. These experimental observations are explained in terms of the kinetic model, since the values of the non-catalytic rate constant, k_1 , which dominates initial the whole reaction, at $B = 1.58$ and 1.25 are approximately equal. Furthermore, k_2 which takes affect at higher conversion levels, is increased with the amine/epoxy ratio. It seems that higher content of hardener leads to more completed reaction of epoxy groups, resulting in a higher degree of epoxide consumption. This was also reported in literature for another epoxy/amine system [26]. Finally, increased ratio of hardener to epoxy results in lower values for the parameter C and higher values for the critical conversion, α_c .

4.4. Kinetics of Araldite AY103/HY956

Subsequently, the second Araldite epoxy/amine system was examined. The effect of isothermal temperature on the degree of curing versus time appears in Fig. 9. Again conversion increases with time with

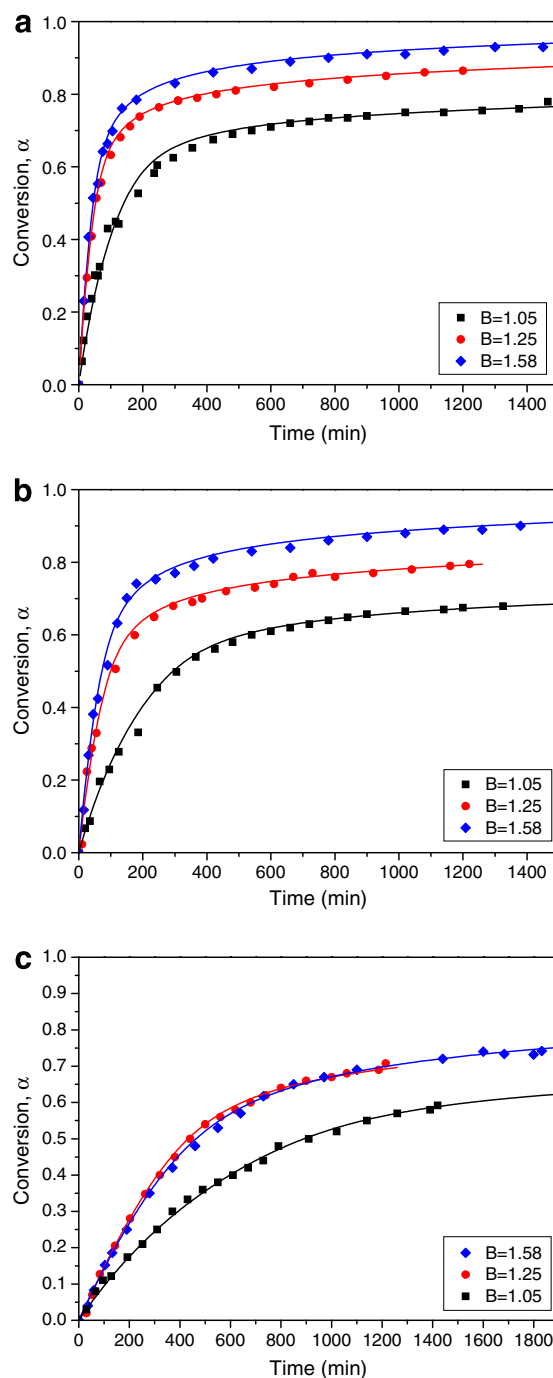


Fig. 8. Effect of the initial amine/epoxy ratio, B , on the extent of conversion vs. time for Araldite 2020, cured at three isothermal temperatures 70 °C (a), 50 °C (b) and 22 °C (c). Experimental data and kinetic model predictions.

an initial high curing rate, which afterwards levels off resulting in a final degree of curing less than 1.

Again, using the procedure described in Section 3.2, the best fitting values of the adjustable parameters were estimated and are illustrated in Table 2. Using these values, the differential Eq. (14) is integrated to provide the theoretical simulation curves of α as a function of time. These lines are also included in Fig. 9 and results are compared to experimental data. Again, the theoretical kinetic model simulates the experimental data very well at all different experimental conditions. From the values reported in Table 2, it can be seen that the estimated values of C were unaffected by temperature, while α_c increased with increasing temperature for the reasons explained in the previous section.

For this adhesive, even though the experimental data reported in Fig. 9, from a first glance resemble with those reported in Fig. 6 for Araldite 2020, from a closer look certain differences for this system were revealed. Initially, it was observed that conversion versus time data follow an S-shaped curve. This can be explained in terms of the kinetic model if the auto-catalytic kinetic rate constant, k_2 , is much larger than k_1 . Indeed, the values estimated for k_2

are nearly ten times those of k_1 . Similar large differences with $k_2 \gg k_1$ have been also reported in literature for other epoxy/amine systems [16,25,27]. Furthermore, comparing the values of k_1 and k_2 obtained from both resins at corresponding conditions, it was observed that the values estimated for k_1 were very similar in contrast to k_2 where in Araldite AY103/HY956 the obtained values were more than ten times those of Araldite 2020. Therefore it was concluded that the mixture of aliphatic amines affects the autocatalytic part very much. From an Arrhenous-type plot of k_1 and k_2 versus temperature, the activation energies E_1 and E_2 can be determined from the slope of the straight lines (Fig. 10). Very good straight lines were obtained for both kinetic rate constants with a correlation coefficient, R , equal to 0.999. Then the values of the activation energies of the non-catalytic and autocatalytic kinetic rate constants were measured to be 51.8 and 47.3 kJ/mol, respectively. These values are close to those reported in literature for DGEBA/TETA 48.8 kJ/mol [43] or DGEBA/DETA 68.8 kJ/mol [44].

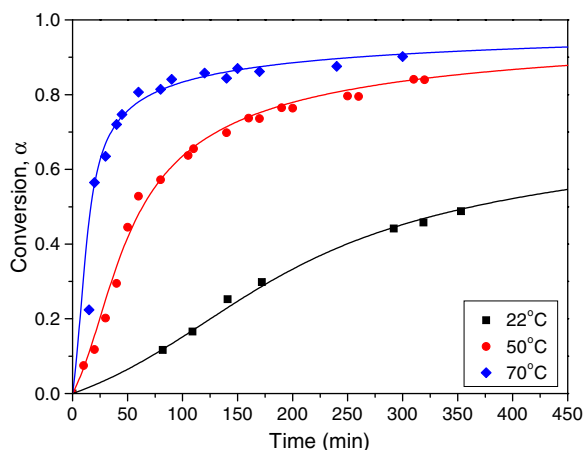


Fig. 9. Effect of isothermal temperature on the extent of conversion vs. time of Araldite AY103/HY956, cured at a constant resin/hardener ratios 100:18 w/w. Experimental data and kinetic model predictions.

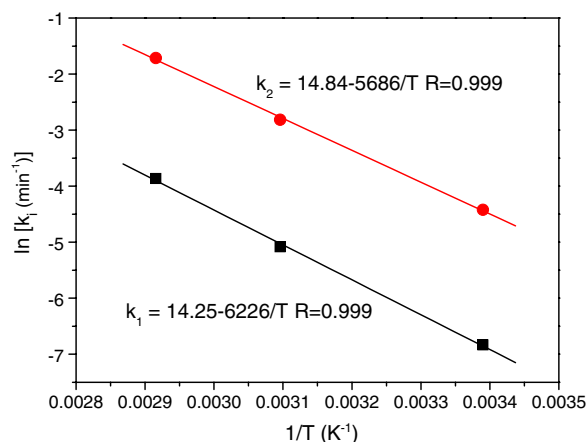


Fig. 10. Arrhenius-type plots of the kinetic rate constant k_1 and the autocatalytic rate constant k_2 as a function of temperature obtained from curing of Araldite AY103/HY956 at an initial resin/hardener ratios 100:18 w/w.

Table 2

Kinetic and diffusional parameters at different temperatures of Araldite AY103/HY 956

Ratio of hardener to epoxy (wt/wt)	Temperature (°C)	$k_1 \times 10^3$ (min ⁻¹)	$k_2 \times 10^3$ (min ⁻¹)	C	α_c
18:100	22	1.08	12	8	0.43
	50	6.2	60	4	0.58
	70	21	180	8	0.65

5. Conclusions

In this study the cure kinetic of two epoxy/amine adhesives used in the restoration of works of art from glass or ceramic was investigated. These were Araldite 2020 and AY103/HY956 and the evolution of epoxy conversion with time was recorded using FTIR. The epoxy resin of both adhesives is based on DGEBA while the amine was a cycloaliphatic in the first case and a mixture of aliphatic in the second. Curing at room temperature is very slow process requiring more than a day to be completed, while curing at higher temperatures (up to 70 °C) leads to increased rates and final epoxy conversions. Furthermore, increased amounts of hardener with respect to resin also result in increased curing rates and final conversions. A kinetic model was employed accounting of both kinetic and diffusional limitations at high conversions and the parameters were evaluated by fitting to experimental data. Kinetics of both resins are very much affected by temperature and to a less extent by the amine/epoxy ratio, with increasing maximum degrees of curing with increasing amine. The mixture of aliphatic amines results in S-shaped conversion-time curves, which are due to larger values of the autocatalytic rate constant compared to the kinetic rate constant.

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